

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S167	135	glass near (substrate or board) and (vias or (through near holes)) and filler and (display near device)	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	OFF	2008/04/11 14:34
S173	1422	(glass adj1 (substrate or board)) and (vias or (through adj1 holes)) and filler and (display adj1 device)	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:35
S172	4045	(glass adj1 (substrate or board)) and (vias or (through adj1 holes)) and filler	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:35
S171	19	361/750 and glass near (substrate or board) and (vias or (through near holes))	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	OFF	2008/04/11 14:35
S170	37	361/748 and glass near (substrate or board) and (vias or (through near holes))	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	OFF	2008/04/11 14:35
S169	8	("4574255"   "5502889"   "5854534"   "5953213"   "6052287"   "6137167"   "6333857"   "6362525"). PN.	USPAT	OR	OFF	2008/04/11 14:35
S168	99	361/760 and glass near (substrate or board) and (vias or (through near holes))	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	OFF	2008/04/11 14:35
S176	8	(glass adj1 (substrate)) and (fill\$3 adj1 vias) and (epoxy adj1 resin) and @pd<"20010101"	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:36
S175	169	(glass adj1 (substrate)) and (fill\$3 adj1 vias) and (display adj1 device)	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:36
S174	2117	(glass adj1 (substrate or board)) and (vias or (through adj1 holes)) and seal\$3 and chromium and copper	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:36

S177	30	(glass adj1 (substrate)) and (fill\$3 adj1 vias) and (display adj1 device) and @pd<"20030101"	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 14:37
L20	81	361/752.ccls. and (display adj2 device)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 15:48
L19	2040	361/752.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 15:48
L21	1883	349/58.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 15:52
L28	1616	349/158.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:05
L27	456	349/150.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:05
L29	3	("5739634").PN. OR ("6392356").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2008/04/11 16:09
L31	77	361/760.ccls. and (display adj2 device)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:13
L30	2190	361/760.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:13

L32	231	361/750.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:17
L34	1439	174/250.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:18
L33	1265	361/748.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:18
L37	2733	174/260.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:19
L36	978	174/256.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:19
L35	2135	174/255.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:19
L38	290	361/751.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:20
L39	135	361/757.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:21

L40	72	361/739.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:22
L41	724	(glass adj1 (substrate or board)) and (vias or (through adj1 holes)) and seal\$3 and (display adj2 (panel or device or apparatus)) and drive\$3 and component.clm.	US-PGPUB; USPAT; EPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:24
L42	606	(glass adj1 (substrate or board)) and (pattern\$2 or trace\$3) and (vias or (through adj1 holes)) and seal\$3 and (display adj2 (panel or device or apparatus)) and drive\$3 and component.clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:27
L44	2058	suzuki adj1 yoshio.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/04/11 16:29
L43	73	matsuda adj1 yoshinari.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/04/11 16:29
L48	138	asai adj1 nobutoshi.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/04/11 16:30
L47	28	odake adj1 ryota.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2008/04/11 16:30
L46	22	suzuki adj1 yoshio.in. and (display adj1 device) and glass and substrate	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2008/04/11 16:30
L49	25	(printed adj2 wir\$4) and (glass adj1 (substrate or board)) and (pattern\$2 or trace\$3) and (vias or (through adj1 holes)) and seal\$3 and (display adj2 (panel or device or apparatus)) and drive\$3 and component.clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/04/11 16:33

4/11/2008 4:35:19 PM

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